

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	ICE3PCS03G	**Issued**	16. January 2020
MA#	MA001039490		
Package	PG-DSO-8-41	**Weight***	81.28 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.250	4.00	4.00	39983	39983
leadframe	inorganic material	phosphorus	7723-14-0	0.008	0.01		104	
	non noble metal	zinc	7440-66-6	0.034	0.04		414	
	non noble metal	iron	7439-89-6	0.673	0.83		8282	
	non noble metal	copper	7440-50-8	27.330	33.63	34.51	336266	345066
wire	noble metal	gold	7440-57-5	0.188	0.23	0.23	2315	2315
encapsulation	organic material	carbon black	1333-86-4	0.142	0.17		1746	
	plastics	epoxy resin	-	4.589	5.65		56465	
	inorganic material	silicondioxide	60676-86-0	42.580	52.39	58.21	523902	582113
leadfinish	non noble metal	tin	7440-31-5	0.814	1.00	1.00	10013	10013
plating	noble metal	silver	7440-22-4	0.090	0.11	0.11	1102	1102
glue	plastics	acrylic resin	-	0.315	0.39		3882	
	noble metal	silver	7440-22-4	1.262	1.55	1.94	15526	19408
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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